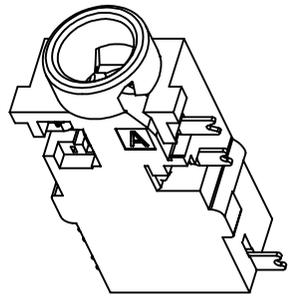
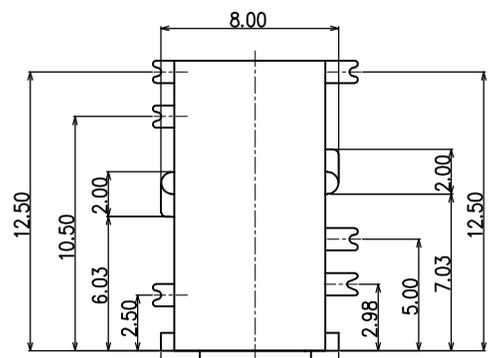
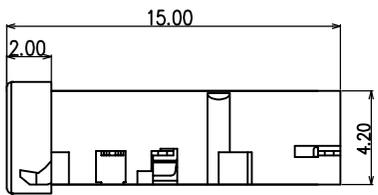
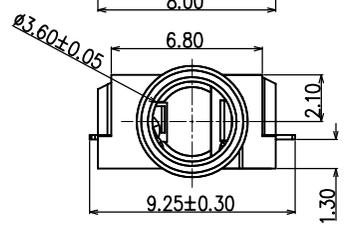


REV.	ECN. NO.	DESCRIPTION	ENG	DATE
A		INITIAL	Kai	2013.07.29

- NOTES:
- CONTACT CURRENT RATING: 1A.
 - CONTACT RESISTANCE: 50 mΩ MAX.;
 - INSULATION RESISTANCE: 100MΩ MIN.;
 - DIELECTRIC WITHSTANDING: 500V AC MIN.;
 - DURABILITY: 5,000 CYCLES MIN.;
 - CONNECTOR MATING FORCES: 30N MAX.;
 - CONNECTOR UNMATING FORCES: 3N MIN.;

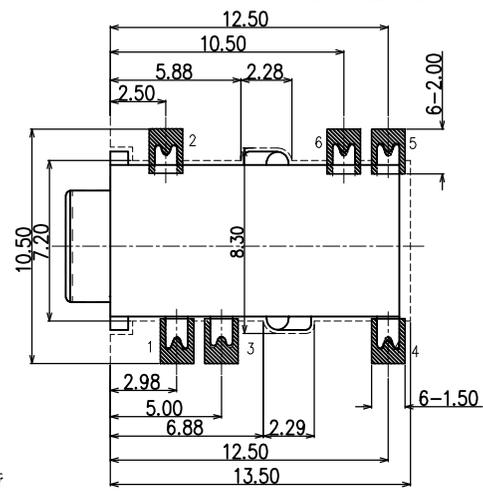


3D VIEW

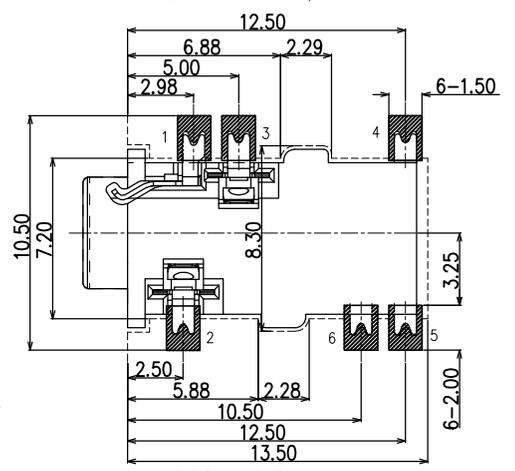


PJ35A051-F06G1ER-X

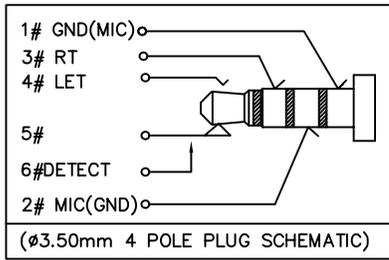
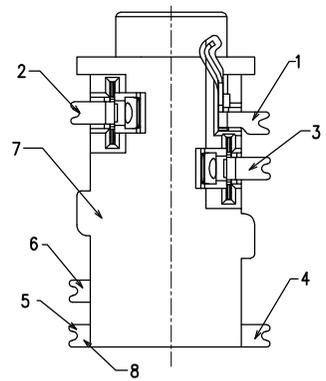
- A: 正编
- B: 反编
- R: 正编载带
- F: 反编载带



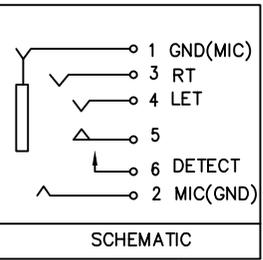
P.C.B LAYOUT TOP VIEW POSITIVE



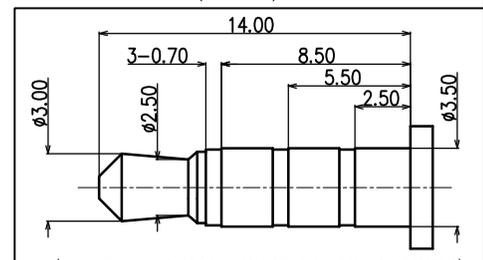
P.C.B LAYOUT TOP VIEW (REVERSE)



(ø3.50mm 4 POLE PLUG SCHEMATIC)



SCHEMATIC



(ø3.50mm 4 POLE PLUG DETAIL DRAWING)

ITEM	NAME	Q'TY	DESCRIPTION	NOTE
8	SEPARATOR	1	HIGHT TEMPERATURE PLASTIC COLOR BLACK	
7	HOUSING	1	HIGHT TEMPERATURE PLASTIC COLOR BLACK	
6	TERMINAL 6#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD PLATING ON SOLDER AREA ;GOLD PLATING ON CONTACT AREA	T=0.20mm
5	TERMINAL 5#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD PLATING ON CONTACT AREA	T=0.20mm
4	TERMINAL 4#	1		T=0.20mm
3	TERMINAL 3#	1	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD PLATING ON SOLDER AREA ;GOLD PLATING ON CONTACT AREA	T=0.20mm
2	TERMINAL 2#	1		T=0.20mm
1	TERMINAL 1#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD PLATING ON SOLDER AREA ;GOLD PLATING ON CONTACT AREA	T=0.20mm

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:		ANGLES:	
DIM	TOL	DIM	TOL
X.	±0.30	X.	±2°
X.X	±0.25	X.X	±1°
X.XX	±0.20	X.XX	—
X.XXX	±0.10	X.XXX	—

XB 东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

DWG NO.		PART NAME:	PHONE JACK
DESIGN:		PART NO.	XB-PJ35A017-F06G1BX-X
CHECK:		REV.	A
APPROVED		UNIT:	mm
		SHEET:	1/1